IPC ASSOCIATION CONNECT ELECTRONICS INDUSTR	Material Compo © Copyright 2005. If international and Pan	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					laterials and	ials and Mfg Information			
upplier Infor	mation				·										
Company name*		Company unique ID			1	Unique ID Authority					Response Date*				
onsemi										2025	2025-05-12				
Contact Name		Title - Contact			]	Phone - Contact*				Emai	Email - Contact*				
Product-Env-Stev	wards		Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com			
uthorized Repre	sentative*	Title - Representative			]	Phone - Representative*				Emai	Email - Representative*				
Product-Env-Stev	wards	Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com				
Reques	Requester Item Number Mfr Iter		m Number Mfr Item Name				Effective Dat	te Version Manufacturing Site		e	Weight*	UOM	Unit Type		
		FDN3041	DN304PZ 20V/8V 52/70/100		)МО РСН		2025-05-12 PBB			10.53	mg	Each			
Ianufacturin	g Proccess Informat	tion													
Terminal Plating / Grid Array Material Terminal Plating / Grid Array Material			Terminal Base Alloy J-STD-020 MS		SL Rating	Peak Process Body Temper		y Temperatu	re Max Time at	Peak Tempe	erature Num	ber of Reflow Cy	cles		
Matte Tin (Sn) - annealed CU			CU Alloy 1				260   C   30			sec	seconds 3				
omments															
vel 1 - maximum	ı time at peak temperatu	re during sol	dering is 10-3	30 seconds											
or more informa	tion regarding material	composition ]	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.766	mg	Supplier	Silicon (Si)	7440-21-3		0.766	mg
Lead Frame	3.66		Supplier	Zinc (Zn)	7440-66-6		0.0044	mg
			Supplier	Iron (Fe)	7439-89-6		0.086	mg
			Supplier	Copper (Cu)	7440-50-8		3.5685	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0011	mg
Lead Frame plating	0.039	mg	Supplier	Silver (Ag)	7440-22-4		0.039	mg
Mold Compound-Black	5.697			Epoxy resin	proprietary data		0.2849	mg
			Supplier	Phenolic Resin	Proprietary Data		0.2849	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.1139	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0285	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.9849	mg
Plating	0.332	mg	Supplier	Tin (Sn)	7440-31-5		0.332	mg
Wire Bond - Cu	0.036	mg	Supplier	Copper (Cu)	7440-50-8		0.036	mg